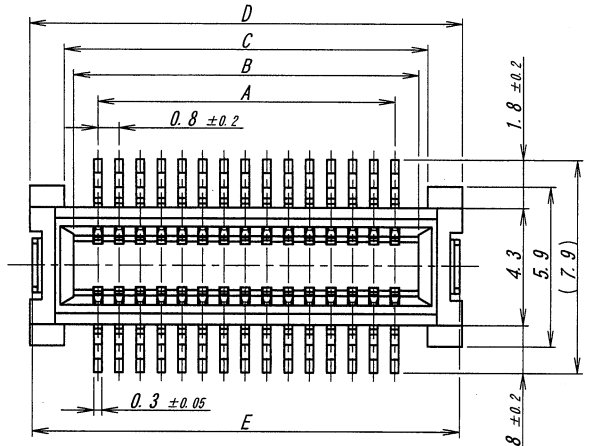
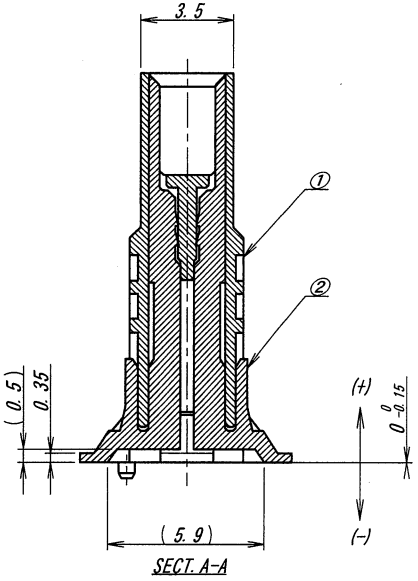
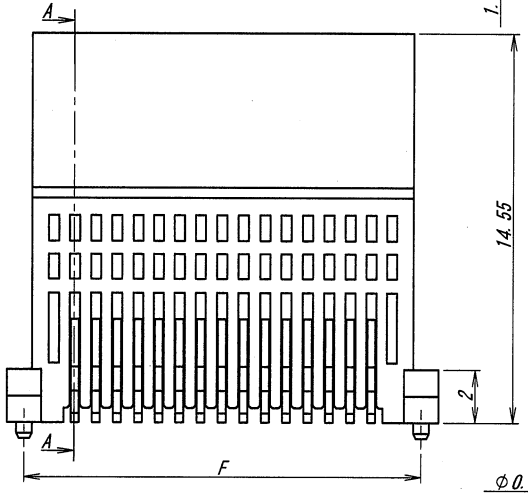
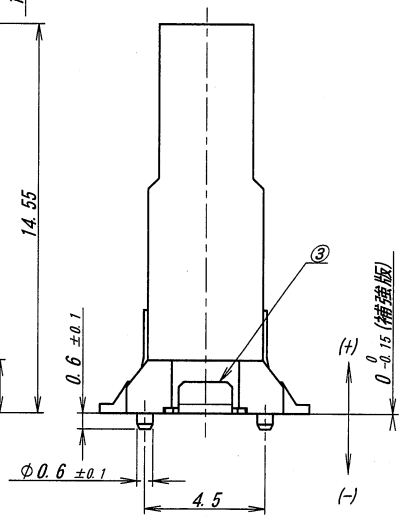
極数/CKT	部品番号/PARTS No.	A	B	C	D	E	F
30	9860B-30C-GFA	11.2	13.0	13.7	16.4	16.1	15.0
40	9860B-40C-GFA	15.2	17.0	17.7	20.4	20.1	19.0
50	9860B-50C-GFA	19.2	21.0	21.7	24.4	24.1	23.0
60	9860B-60C-GFA	23.2	25.0	25.7	28.4	28.1	27.0
70	9860B-70C-GFA	27.2	29.0	29.7	32.4	32.1	31.0
80	9860B-80C-GFA	31.2	33.0	33.7	36.4	36.1	35.0
90	9860B-90C-GFA	35.2	37.0	37.7	40.4	40.1	39.0
100	9860B-100C-GFA	39.2	41.0	41.7	44.4	44.1	43.0
110	9860B-110C-GFA	43.2	45.0	45.7	48.4	48.1	47.0
120	9860B-120C-GFA	47.2	49.0	49.7	52.4	52.1	51.0

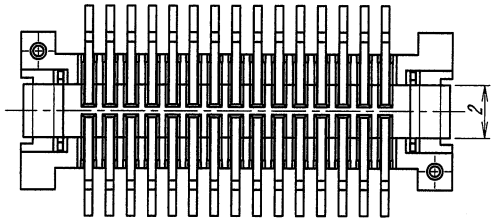


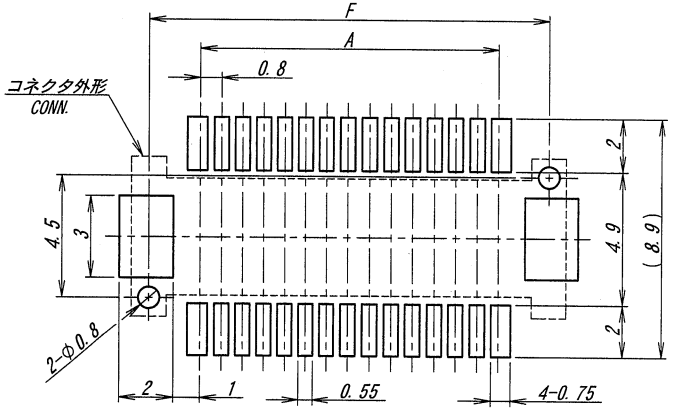


SECT. A-A



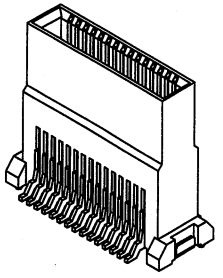


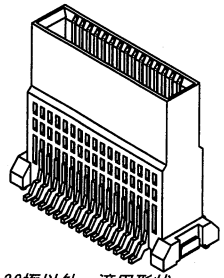




推奨基板寸法
一般公差：±0.05（マウント面）
RECOMMENDED PCB SIZE
GENERAL TORERANCE : ±0.05
(MOUNTING SIDE)

NOTE
1. 端子及び補強板相互間のバラツキ
COPLANALITY (WITH METAL FLANGE) : 0.1MAX.
2. ブリスター梱包品/PACKING OF BLISTER


30極 適用形状
ONLY 30CKT APPLY.


30極以外 適用形状
APPLIES EXCLUDING 30CKT.

LTR 記号	ECN No	REVISION RECORD 記事	DR	CHK	DATE 年月日
△					
△					
△					
△					
△					
△					
ⓓ	28026	RELEASED	K.S	S.M	'07-1-16

MATERIAL 材質
①ベース/BASE
：ガラス入り樹脂/GLASS FILLED PLASTICS
自然色/NATURAL UL94V-0
②ポスト/POST
：銅合金/COPPER ALLOY
③補強板/METAL FLANGE
：銅合金/COPPER ALLOY

FINISH 仕上げ
②ポスト/POST
：ニッケル下地めっき/OVER Ni PLATE:2μmMIN.
：金めっき（接点）/Au PLATE (CONTACT POINT) :0.1μmMIN.
（テール部）/(SOLDER TAIL) :0.03μmMIN.
封孔処理済/SEALING TREATMENT.
③補強板/METAL FLANGE
：ニッケル下地めっき/OVER Ni PLATE:1~3μm.
：スズ-銅めっき/TIN-COPPER PLATE:2~5μm.

GENERAL TOLERANCES 一般公差
DIM 寸法 ±0.3
ANGLE 角度 ±

3RD. ANG. PROJ. 三角法

SCALE 尺度	1/1
UNIT 単位	mm
DR '07-1-16	K. Sato
DSN '04-10-15	H. Honma
CHK '07/1/16	A. Matsuzaki
APP '07	Y.16 M. Mukada

IRISO ELECTRONICS CO., LTD
イリソ電子工業株式会社

TITLE 名称: 9860シリーズ プラグ / SERIES 9860 PLUG
EDP No:
PARTS No 部番: 9860B-**C-GFA
DWG No 図番: IMSA-9860B-**C-GFA
REV.: 0

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